

**TRISIL**
**DESCRIPTION**

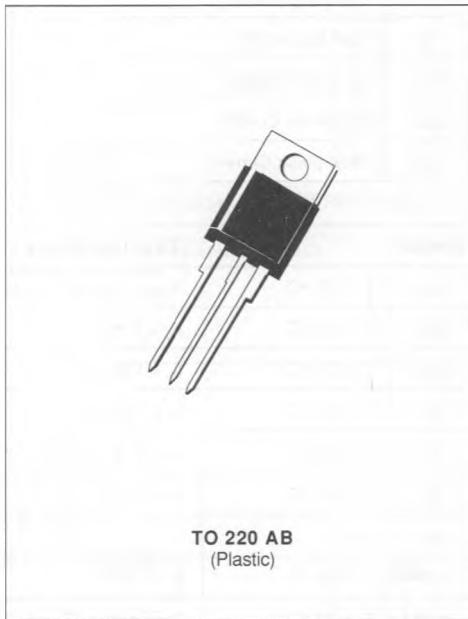
This protection device has been especially designed for subscriber line-card and terminal protection. By itself, it enables to protect integrated SLIC against transient overvoltages. A diode clips positive overloads and breakdown device negative overloads.

Its ion-implanted technology confers excellent electrical characteristics on it.

This is why this THBT 200 D easily corresponds to the main protection standard norms which are related to the overvoltages on subscribers lines.

**IN ACCORDANCE WITH FOLLOWING STANDARDS :**

CCITT K17 - K20	{	10/700 µs	1.5 kV
	l	5/310 µs	38 A
VDE 0433	{	10/700 µs	2 kV
	l	5/200 µs	50 A
CNET	{	0.5/700 µs	1.5 kV
	l	0.2/310 µs	38 A


**ABSOLUTE RATINGS (limiting values) ( $T_j = 25^\circ\text{C}$ )**

Symbol	Parameter	Value	Unit
$I_{pp}$	Peak Pulse Current	1 ms expo	A
		8-20 µs expo*	A
$I_{TSM}$	Non Repetitive Surge Peak on-state Current	$t_p = 20$ ms	A
$dI/dt$	Critical Rate of Rise of on-state Current	Non Repetitive	$\text{A}/\mu\text{s}$
$T_{sig}$ $T_i$	Storage and Operating Junction Temperature Range	- 40 to 150 150	$^\circ\text{C}$ $^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering During 10 s at 4 mm from Case	230	$^\circ\text{C}$

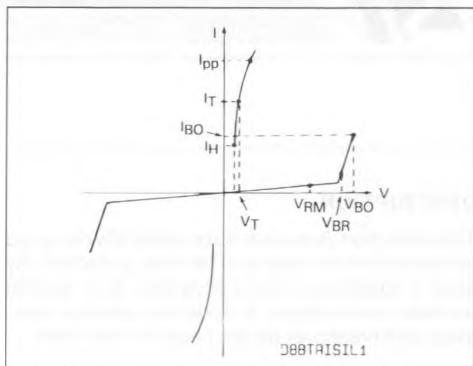
\* ANSI STD C62.

**THERMAL RESISTANCES**

Symbol	Parameter	Value	Unit
$R_{th(j-c)}$	Junction to Case for DC	5	$^\circ\text{C}/\text{W}$
$R_{th(j-a)}$	Junction to Ambient	60	$^\circ\text{C}/\text{W}$

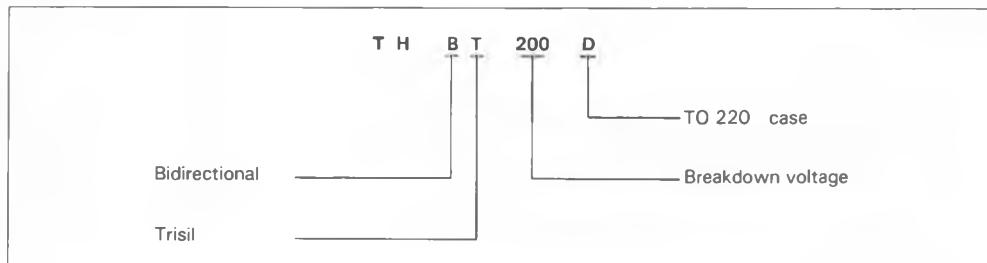
## ELECTRICAL CHARACTERISTICS

Symbol	Parameter
$V_{RM}$	Stand-off Voltage
$V_{BR}$	Breakdown Voltage
$V_{BO}$	Clamping Voltage
$I_H$	Holding Current
$V_T$	On-state Voltage
$I_{BO}$	Breakover Current
$I_{pp}$	Peak-pulse Current



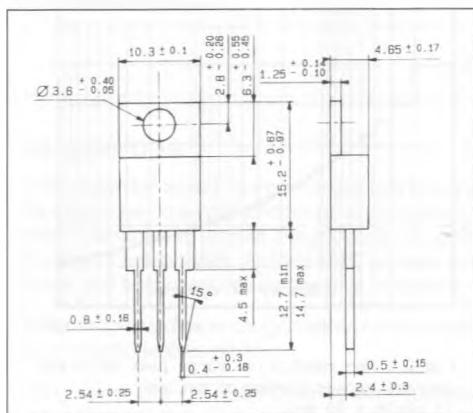
Symbol	Test Conditions			Min.	Typ.	Max.	Unit
$I_{RM}$	$T_j = 25^\circ\text{C}$	$V_{RM} = 180\text{ V}$				10	$\mu\text{A}$
$V_{BR}$	$T_j = 25^\circ\text{C}$	$I_R = 1\text{ mA}$		200			V
$V_{BO}$	$T_j = 25^\circ\text{C}$	$t_p = 100\text{ }\mu\text{s}$				290	V
$I_{BO}$	$T_j = 25^\circ\text{C}$	$t_p = 100\text{ }\mu\text{s}$		150		800	mA
$I_H$	$T_j = 25^\circ\text{C}$	$I_T = 2\text{ A}$		150			mA
$V_T$	$T_j = 25^\circ\text{C}$	$I_T = 5\text{ A}$	$t_p = 100\text{ }\mu\text{s}$			3	V
$\alpha_T$					20		$10^{-3}/^\circ\text{C}$
C	$T_j = 25^\circ\text{C}$	$F = 1\text{ MHz}$	$V_R = 5\text{ V}$			200	pF
$dv/dt$	$T_j = 25^\circ\text{C}$	Exponential Ramp 67 % $V_{BR}$		5000			V/ $\mu\text{s}$

## ORDER CODE

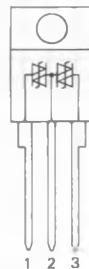


## PACKAGE MECHANICAL DATA

TO 220 AB Plastic



## PIN CONNECTIONS



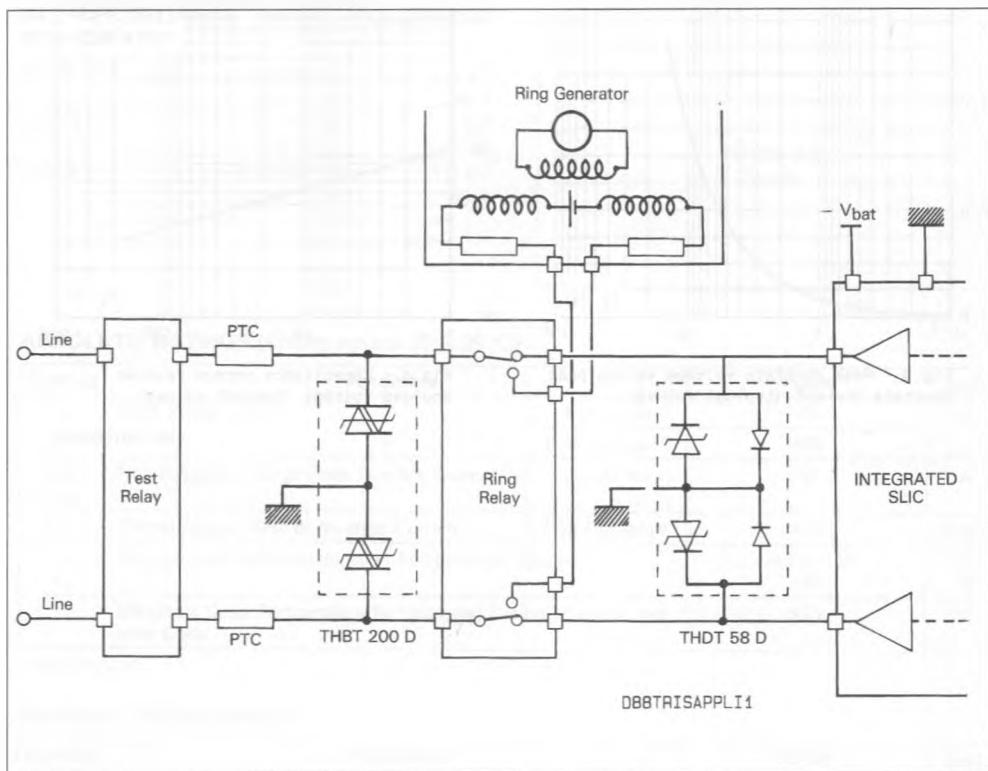
D88TRIST02201

Cooling method : by conduction (Method C)

Marking type number

Weight : 2 g.

## APPLICATION CIRCUIT



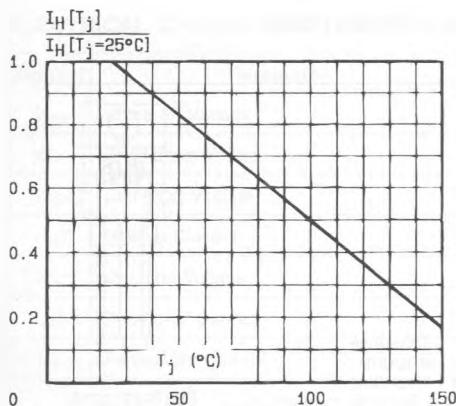


Fig.1 - Relative variation of holding current versus junction temperature.

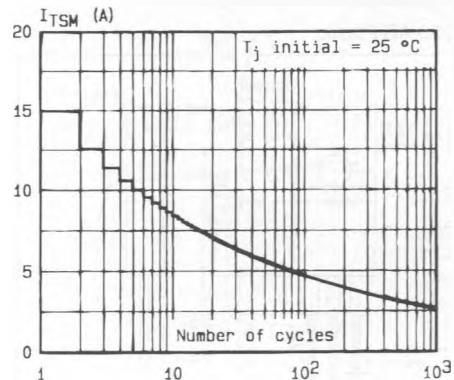


Fig.2 - Non-repetitive surge peak on-state current versus number of cycles  
(1 cycle = 20 ms).

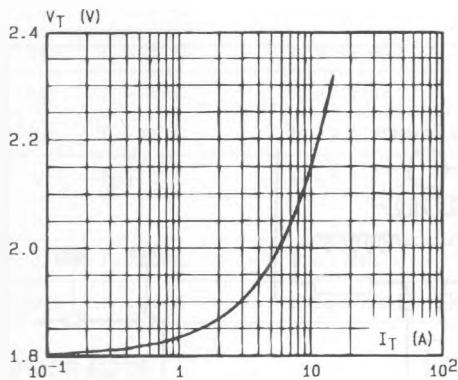


Fig.3 - Peak on-state voltage versus peak on-state current (typical values).

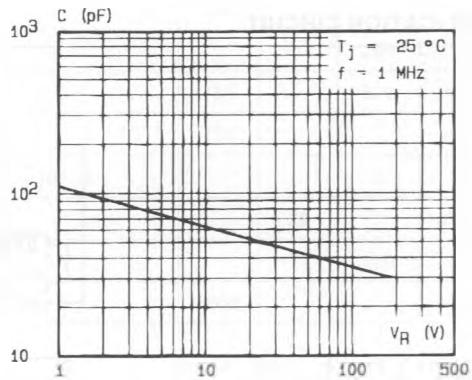


Fig.4 - Capacitance versus reverse applied voltage (typical values).

089THBT200DP4